

Features

- Compliant with AEC-Q200 Rev-D Stress Test Qualification for Passive Components in Automotive Applications
- 100 % electrically compatible with all previous generations of 1812 SMT devices
- Compatible with Pb and Pb-free solder reflow profiles
- RoHS compliant* and halogen free**
- Surface mount packaging for automated assembly
- Agency recognition: c¶us ≜
- Standard 4532 mm (1812 mils) footprint

MF-MSMF Series - PTC Resettable Fuses

Electrical Characteristics

Model	V _{max}	ax I _{max}	I _{hold}	I _{trip}		tance	Max. Time to Trip		Tripped Power Dissipation	Power Recognition		AEC-Q200
			at 2	at 23 °C		at 23 °C Ohms		23 °C	at 23 °C Watts	cUL	ΤÜV	Compliant
	Volts	Amps	An	nps	R _{Min}	R _{1Max}	Amps	Seconds	Тур.	E174545	R50256634	
MF-MSMF010	60	40	0.1	0.3	0.7	15	0.5	1.5	0.8	✓	√	✓
MF-MSMF014	60	40	0.14	0.3	0.4	6.5	1.5	0.2	0.8	✓	✓	✓
MF-MSMF020	30	80	0.2	0.4	0.4	6.0	6.0	0.1	0.8	✓	✓	✓
MF-MSMF020/60	60	40	0.2	0.4	0.4	6.0	1.5	0.2	0.8	✓	1	✓
MF-MSMF030	30	10	0.3	0.6	0.3	3.0	8.0	0.1	0.8	√	✓	✓
MF-MSMF050	15	100	0.5	1.0	0.15	1.0	8.0	0.2	0.8	✓	✓	✓
MF-MSMF050/30X	30	40	0.5	1.0	0.15	1.3	8.0	0.2	0.8	√	1	✓
MF-MSMF050/40X	40	20	0.5	1.0	0.15	1.3	8.0	0.2	0.8	\		
MF-MSMF075	13.2	100	0.75	1.5	0.11	0.45	8.0	0.2	0.8	✓	✓	✓
MF-MSMF075/24	24	40	0.75	1.5	0.11	0.45	8.0	0.2	0.8	√	✓	✓
MF-MSMF075/33X	33	20	0.8	1.5	0.11	0.40	8.0	0.2	1.4	✓		✓
MF-MSMF110	6	100	1.1	2.2	0.04	0.21	8.0	0.3	0.8	√	1	
MF-MSMF110/16	16	100	1.1	2.2	0.04	0.21	8.0	0.3	0.8	✓	✓	✓
MF-MSMF110/24X	24	20	1.1	2.2	0.06	0.18	8.0	0.5	0.8	✓	✓	✓
MF-MSMF125	6	100	1.3	2.5	0.05	0.14	8.0	0.4	0.8	✓	✓	
MF-MSMF150	6	100	1.5	3.0	0.03	0.12	8.0	0.5	0.8	✓	✓	
MF-MSMF150/12	12	100	1.5	3.0	0.03	0.12	8.0	0.5	0.8	✓	✓	✓
MF-MSMF150/24X	24	20	1.5	3.0	0.03	0.12	8.0	1.5	1.0	✓	✓	✓
MF-MSMF160	8	100	1.6	2.8	0.035	0.099	8.0	2.0	0.8	✓	✓	
MF-MSMF200	8	40	2.0	4.0	0.020	0.080	8.0	2.0	0.8	✓	✓	
MF-MSMF250/16X	16	100	2.5	5.0	0.015	0.100	8.0	5.0	1.2	✓	1	✓
MF-MSMF260	6	100	2.6	5.2	0.015	0.080	8.0	5.0	0.8	✓	1	
MF-MSMF260/16X	16	100	2.6	5.0	0.015	0.050	8.0	5.0	1.2	✓	√	✓
MF-MSMF300X	6	100	3.0	5.0	0.010	0.040	8.0	5.0	1.2	✓		

Environmental Characteristics

Item	Condition	Criteria
Operating Temperature	-40 °C to +85 °C	
Recommended Storage	+40 °C max. / 70 % R.H. max.	
Passive Aging	+85 °C, 1000 hours	±5 % typical resistance change
Humidity Aging	+85 °C, 85 % R.H. 1000 hours	±5 % typical resistance change
Thermal Shock	-40 °C to +85 °C, 20 times	±10 % typical resistance change
Solvent Resistance	MIL-STD-202, Method 215	No change (marking still legible)
Vibration	MIL-STD-883C, Method 2007.1 Condition A	No change (R _{min} < R < R _{1max})
Moisture Sensitivity Level (MSL)	See Note	
ESD Classification	Class 6 (per AEC-Q200-2, HBM)	



^{**} Bourns considers a product to be "halogen free" if (a) the Bromine (Br) content is 900 ppm or less; (b) the Chlorine (CI) content is 900 ppm or less; and (c) the total Bromine (Br) and Chlorine (CI) content is 1500 ppm or less.

Specifications are subject to change without notice. Users should verify actual device performance in their specific applications. The products described herein and this document are subject to specific

Applications

- Overcurrent and overtemperature protection of automotive electronics
- Hard disk drives
- PC motherboards
- PC peripherals

- Point-of-sale (POS) equipment
- PCMCIA cards
- USB port protection USB 2.0, 3.0 & OTG
- HDMI 1.4 Source protection

MF-MSMF Series - PTC Resettable Fuses

Test Procedures and Requirements

Item	Test Condition	Accept/Reject Criteria
Visual/Mechanical	Verify dimensions and materials	Per MF physical description
Resistance	In still air @ 23 °C	$R_{min} \le R \le R_{max}$
Time to Trip	At specified current, V _{max} , 23 °C, still air	T ≤ max. time to trip (seconds)
Hold Current	30 min. at I _{hold} , still air	No trip
Trip Cycle Life	V _{max} , I _{max} , 100 cycles	No arcing or burning
Trip Endurance	V _{max} , I _{max} , 48 hours	No arcing or burning
Solderability	245 °C ±5 °C, 5 seconds	95 % min. coverage

Product Dimensions (see next page for outline drawings)

Model	Style		A	E	3	С		D
Model		Min.	Max.	Min.	Max.	Min.	Max.	Min.
MF-MSMF010								
MF-MSMF014			4.73				1.10 (0.043)	
MF-MSMF020]]	4.37		3.07	3.41 (0.134)	0.70 (0.028)		
MF-MSMF020/60	1	$\frac{4.37}{(0.172)}$	(0.186)	(0.121)				
MF-MSMF030								
MF-MSMF050								
MF-MSMF050/30X	2	4.37	4.83	3.07	3.41	0.40	0.85	
MF-MSMF050/40X		(0.172)	(0.190)	(0.121)	(0.134)	(0.016)	(0.033)	
MF-MSMF075	1	4.37	4.73	_3.07_	3.41	0.55	_0.85_	
MF-MSMF075/24	'	(0.172)	(0.186)	(0.121)	(0.134)	(0.022)	(0.033)	
MF-MSMF075/33X	2	4.37	4.83	3.07	3.41	0.70	1.60	
		(0.172)	(0.190)	(0.121)	(0.134)	(0.028)	(0.063)	
MF-MSMF110	1	4.37	_4.73_	3.07	3.41	0.55	0.85	
MF-MSMF110/16	'	(0.172)	(0.186)	(0.121)	(0.134)	(0.022)	(0.033)	
MF-MSMF110/24X	2	$\frac{4.37}{(0.172)}$	4.83 (0.190)	3.07 (0.121)	3.41 (0.134)	0.70 (0.028)	1.60 (0.063)	0.30 (0.012)
MF-MSMF125		4.07	4.70	0.07	0.44	0.55	0.05	(0.012)
MF-MSMF150		$\frac{4.37}{(0.172)}$	4.73 (0.186)	3.07 (0.121)	3.41 (0.134)	<u>0.55</u> (0.022)	$\frac{0.85}{(0.033)}$	
MF-MSMF150/12		(0.172)	(0.166)	(0.121)	(0.134)	(0.022)	(0.033)	
MF-MSMF150/24X	2	4.37 (0.172)	4.83 (0.190)	3.07 (0.121)	3.41 (0.134)	0.70 (0.028)	1.60 (0.063)	
MF-MSMF160	4	4.37 (0.172)	4.73 (0.186)	3.07 (0.121)	3.41 (0.134)	0.55 (0.022)	0.85 (0.033)	
MF-MSMF200] '	4.37 (0.172)	4.73 (0.186)	3.07 (0.121)	3.41 (0.134)	0.45 (0.018)	0.85 (0.033)	
MF-MSMF250/16X	2	4.37 (0.172)	4.83 (0.190)	3.07 (0.121)	3.41 (0.134)	0.70 (0.028)	1.60 (0.063)	
MF-MSMF260	1	4.37 (0.172)	4.73 (0.186)	3.07 (0.121)	3.41 (0.134)	0.45 (0.018)	0.85 (0.033)	
MF-MSMF260/16X MF-MSMF300X	- 2	4.37 (0.172)	4.83 (0.190)	3.07 (0.121)	3.41 (0.134)	0.70 (0.028)	1.60 (0.063)	

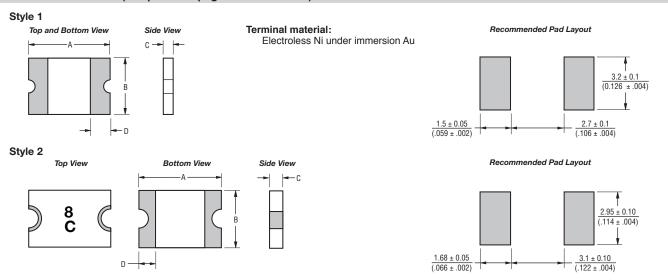
DIMENSIONS:

(INCHES)

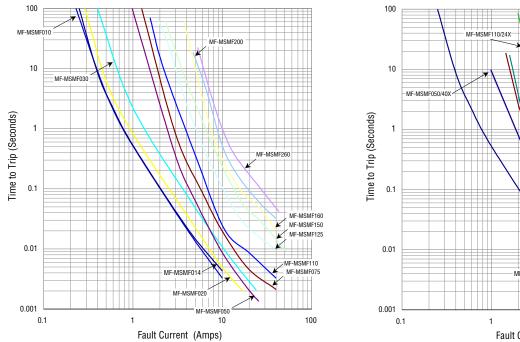
MF-MSMF Series - PTC Resettable Fuses

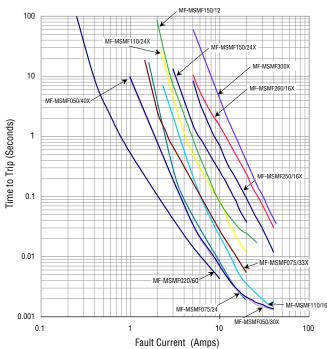
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Product Dimensions (see previous page for dimensions)



Typical Time to Trip at 23 °C





The Time to Trip curves represent typical performance of a device in a simulated application environment. Actual performance in specific customer applications may differ from these values due to the influence of other variables.

MF-MSMF Series - PTC Resettable Fuses

Thermal Derating Table - Ihold (Amps)

	Ambient Operating Temperature									
Model	-40 °C	-20 °C	0 °C	23 °C	40 °C	50 °C	60 °C	70 °C	85 °C	
MF-MSMF010	0.16	0.14	0.12	0.10	0.08	0.07	0.06	0.05	0.03	
MF-MSMF014	0.23	0.20	0.17	0.14	0.12	0.10	0.09	0.08	0.06	
MF-MSMF020	0.30	0.27	0.23	0.20	0.17	0.15	0.13	0.12	0.09	
MF-MSMF020/60	0.29	0.26	0.23	0.20	0.17	0.15	0.13	0.11	0.08	
MF-MSMF030	0.46	0.40	0.36	0.30	0.26	0.22	0.20	0.18	0.14	
MF-MSMF050	0.77	0.68	0.59	0.50	0.44	0.40	0.37	0.33	0.29	
MF-MSMF050/30X	0.77	0.68	0.59	0.50	0.44	0.40	0.37	0.33	0.25	
MF-MSMF050/40X	0.77	0.68	0.59	0.50	0.44	0.40	0.37	0.33	0.25	
MF-MSMF075	1.15	1.01	0.88	0.75	0.65	0.60	0.55	0.49	0.43	
MF-MSMF075/24	1.15	1.01	0.88	0.75	0.65	0.60	0.55	0.49	0.43	
MF-MSMF075/33X	1.16	1.03	0.90	0.75	0.63	0.56	0.49	0.42	0.32	
MF-MSMF110	1.59	1.43	1.26	1.10	0.95	0.87	0.80	0.71	0.60	
MF-MSMF110/16	1.59	1.43	1.26	1.10	0.95	0.87	0.80	0.71	0.60	
MF-MSMF110/24X	2.00	1.70	1.40	1.10	0.95	0.88	0.80	0.73	0.61	
MF-MSMF125	2.00	1.69	1.47	1.25	1.03	0.92	0.90	0.69	0.53	
MF-MSMF150	2.17	1.95	1.72	1.50	1.30	1.18	1.09	0.97	0.82	
MF-MSMF150/12	2.17	1.95	1.72	1.50	1.30	1.18	1.09	0.97	0.82	
MF-MSMF150/24X	2.10	1.90	1.70	1.50	1.25	1.13	1.00	0.88	0.69	
MF-MSMF160	2.30	2.20	1.90	1.60	1.45	1.30	1.15	1.03	0.91	
MF-MSMF200	3.08	2.71	2.35	2.00	1.80	1.60	1.50	1.40	1.25	
MF-MSMF250/16X	3.90	3.42	2.96	2.50	2.24	1.98	1.85	1.29	0.94	
MF-MSMF260	3.40	3.16	2.90	2.60	2.32	2.18	2.00	1.90	1.69	
MF-MSMF260/16X	3.50	3.20	3.00	2.60	2.30	2.15	2.00	1.85	1.63	
MF-MSMF300X	4.13	3.75	3.33	3.00	2.70	2.54	2.35	2.22	1.98	

Packaging Quantity

MF-MSMF010 ~ MF-MSMF030 = 1500 pcs. per reel

MF-MSMF050 ~ MF-MSMF260 = 2000 pcs. per reel

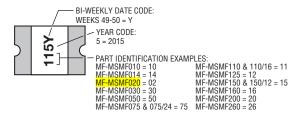
 $MF-MSMF075/33X, MF-MSMF110/24X, MF-MSMF150/24X, MF-MSMF250/16X, MF-MSMF260/16X \& MF-MSMF300X = 1500 \ pcs. \ per \ reel \ means a constant of the control of the control$

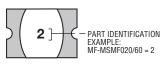


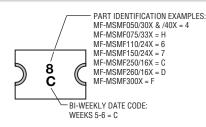
MF-MSMF Series - PTC Resettable Fuses

Typical Part Marking

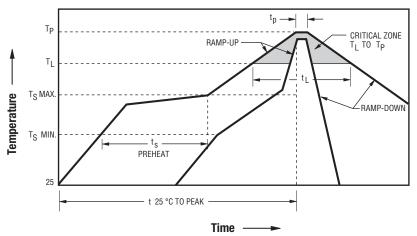
Represents total content. Layout may vary.







Solder Reflow Recommendations



- · MF-MSMF models are intended for reflow soldering (including but not limited to heating plate, hot air, IR, nitrogen, and vapor phase).
- Wave soldering is permissible only if the device is on the top of the PCB, opposite the heat source.
- Hand soldering is not recommended for these devices.
- All temperatures refer to the topside of the device, measured on the device body surface.
- If reflow temperatures exceed the recommended profile, devices may not meet the published specifications.
- Compatible with Pb and Pb-free solder reflow profiles.
- Excess solder may cause a short circuit.

How to Order

Multifuse® Product Designator Series

Please refer to the Multifuse® Polymer PTC Resettable Fuse Soldering Recommendations document for more

Profile Featu	Pb-Free Assembly			
Average Ramp-Up Rate (Ts _{max} t	to T _p)	3 °C / second max.	-	
PREHEAT:	•			
Temperature Min. (Ts _{min})		150 °C		
Temperature Max. (Ts _{max})		200 °C		
Time (Tieces) o Ts _{max}) (ts)	Materials	60~180 seconds	Time	
test board (8 - 10 mil thick) All	n 96.5 / Ag 3.0 / Cu 0.5 loy water soluble or no ean solder paste	217 C emperature 60~150 seconds	Interval	
Peak Temperature (T _p) (s	see note 1)	260 °C		
Time within 5 °C of Actual Peak	ngle sided epoxy glass Fempgraturo(Ipd)	20~40 seconds		
Ramp-Down Rate • PC	board approx. 4x4x.06	ⁿ 6 °C / second max.		
2-Place test units onto board erature	its/board	8 minutes max.		
	vection oven	(see note 2)	2.5 °C ± 0.5 °/se	
4. Preheat (T _S)		150 °C to 190 °C	90 ± 30 sec.	
5. Time above liquidus (T _L)		220 °C	60-90 sec.	
61PelalStorffpStathte \$TIP)EV. AR, 05. Specifications are subject to change without		250 °C +0 °/-5 ° 10-20 sec. within		

B) Unacceptable (see Figure 2)

board assemblies IPC-A-610): A) AcceptaBlentsee Standard Voltage

(1) Solder connection wetting angle exceeding

Inspect of the state of the sta

/30(1/3) he solder correction volume grangle (solder to component a Hulling of the CB definition) does not exceed 90°.

(23 Solater balls Rhalf do not violate minimum Packeteetriver Eleanances and are attached (soldered) to a metal surface.

MF - MSMF 075/24 - 2

- (3) Dewetting.
- (2) Incomplete reflow of solder paste.
- The products described herein and this document are subject to specific legal disclaimers as satisfy the satisfy the last page of this document and at your bourns con docs legal disclaimer per to (see note 2) next run.
- 8 Cleaning water clean profile High pressure deignized

Users should verify actual device performance in their specific applications.

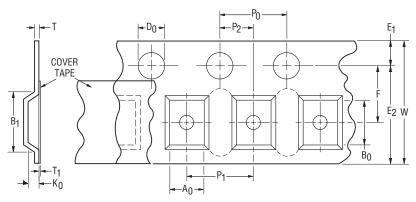
72 °F to 160 °F

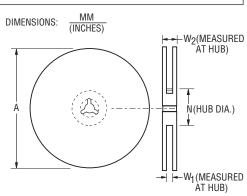
5 °C of peak

MF-MSMF Series Tape and Reel Specifications

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Tape Dimensions per EIA-481	MF-MSMF010 MF-MSMF014 MF-MSMF020 MF-MSMF020/60 MF-MSMF030	MF-MSMF050 MF-MSMF050/30X MF-MSMF125 MF-MSMF050/40X MF-MSMF150 MF-MSMF075 MF-MSMF150/12 MF-MSMF110 MF-MSMF110 MF-MSMF200 MF-MSMF110/16 MF-MSMF260	MF-MSMF075/33X MF-MSMF110/24X MF-MSMF150/24X MF-MSMF250/16X MF-MSMF260/16X MF-MSMF300X					
W		$\frac{12.00 \pm 0.30}{(0.472 \pm 0.012)}$						
P ₀		$\frac{4.00 \pm 0.10}{(0.157 \pm 0.004)}$						
10 P ₀		$\frac{40.00 \pm 0.20}{(1.575 \pm 0.008)}$						
P ₁		$\frac{8.00 \pm 0.10}{(0.315 \pm 0.004)}$						
		$\frac{(0.315 \pm 0.004)}{2.00 \pm 0.05}$						
P ₂		(0.079 ± 0.002)						
A ₀	$\frac{3.58 \pm 0.10}{(0.141 \pm 0.004)}$	$\frac{3.66 \pm 0.15}{(0.144 \pm 0.006)}$	$\frac{3.70 \pm 0.10}{(0.146 \pm 0.004)}$					
В ₀	$\frac{4.93 \pm 0.10}{(0.194 \pm 0.004)}$	$\frac{4.98 \pm 0.15}{(0.196 \pm 0.006)}$	$\frac{5.10 \pm 0.10}{(0.201 \pm 0.004)}$					
B ₁ max.	(5.16.1 2.36.1) 5.90 (0.232)							
D ₀	1.50 +0.10/-0							
0	(0.059 +0.004/-0)							
F		$\frac{5.50 \pm 0.05}{(0.217 \pm 0.002)}$						
E ₁		$\frac{1.75 \pm 0.10}{(0.069 \pm 0.004)}$						
E ₂ typ.		10.25 (0.404)						
T max.		0.60						
T THEX.		(0.024)						
T ₁ max.		<u>0.10</u> (0.004)						
К ₀	$\frac{1.30 \pm 0.10}{(0.051 \pm 0.004)}$	$\frac{0.95 \pm 0.10}{(0.037 \pm 0.004)}$	$\frac{1.50 \pm 0.10}{(0.059 \pm 0.004)}$					
Leader min.		390 (15.4)						
Trailer min.		160 (6.3)						
Reel Dimensions		. ,						
A max.		<u>185</u> (7.3)						
N min.		(7.3) <u>50</u> (2.0)						
W ₁	12.4 +2.0/-0 (0.49 +0.08/-0)							
W ₂ max.		18.4 (0.72)						





Bourns® Multifuse® PPTC Resettable Fuses

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Application Notice

- Users are responsible for independent and adequate evaluation of Bourns® Multifuse® Polymer PTC devices in the user's
 application, including the PPTC device characteristics stated in the applicable data sheet.
- Polymer PTC devices must not be allowed to operate beyond their stated maximum ratings. Operation in excess of such
 maximum ratings could result in damage to the PTC device and possibly lead to electrical arcing and/or fire. Circuits with
 inductance may generate a voltage above the rated voltage of the polymer PTC device and should be thoroughly evaluated
 within the user's application during the PTC selection and qualification process.
- Polymer PTC devices are intended to protect against adverse effects of temporary overcurrent or overtemperature
 conditions up to rated limits and are not intended to serve as protective devices where overcurrent or overvoltage conditions
 are expected to be repetitive or prolonged.
- In normal operation, polymer PTC devices experience thermal expansion under fault conditions. Thus, a polymer PTC
 device must be protected against mechanical stress, and must be given adequate clearance within the user's application to
 accommodate such thermal expansion. Rigid potting materials or fixed housings or coverings that do not provide adequate
 clearance should be thoroughly examined and tested by the user, as they may result in the malfunction of polymer PTC
 devices if the thermal expansion is inhibited.
- Exposure to lubricants, silicon-based oils, solvents, gels, electrolytes, acids, and other related or similar materials may adversely affect the performance of polymer PTC devices.
- Aggressive solvents may adversely affect the performance of polymer PTC devices. Conformal coating, encapsulating, potting, molding, and sealing materials may contain aggressive solvents including but not limited to xylene and toluene, which are known to cause adverse effects on the performance of polymer PTCs. Such aggressive solvents must be thoroughly cured or baked to ensure their complete removal from polymer PTCs to minimize the possible adverse effect on the device.
- Recommended storage conditions should be followed at all times. Such conditions can be found on the applicable data sheet and on the Multifuse® Polymer PTC Moisture/Reflow Sensitivity Classification (MSL) note: https://www.bourns.com/docs/RoHS-MSL/msl mf.pdf

Legal Disclaimer Notice



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